

AMENDMENTS TO THE CLAIMS

1. (Currently Amended) A method of applying viscous medium on a substrate, ~~said substrate being arranged for mounting of components thereon~~, said method comprising the steps of:

providing a substrate arranged for mounting of electronic components thereon;

screen printing predetermined amounts of a viscous medium on predetermined positions on the substrate; and

add-on jetting of predetermined additional amounts of viscous medium on predetermined positions on the screen printed substrate ~~prior to hardening of~~ while the screen printed viscous medium is still in viscous form.

2. (Original) The method according to claim 1, further comprising the steps of:
inspecting the results of said screen printing and add-on jetting;
determining errors of said screen printing and add-on jetting based on said inspection;
determining whether correction is required; and
correcting, if correction is required, at least some of said errors, wherein said correction comprises supplemental jetting of additional viscous medium onto the screen printed substrate.

3. (Original) The method according to claim 1, comprising the steps of:
inspecting the results of said screen printing prior to said add-on jetting;
determining errors of said screen printing based on said inspection;
determining whether correction is required; and

correcting, if correction is required, at least some of said errors, wherein said correcting comprises supplemental jetting of additional viscous medium onto the screen printed substrate.

4. (Original) The method according to claim 3, wherein said supplemental jetting is performed in connection with performing said add-on jetting.

5. (Original) The method according to claim 2 or 3, wherein said add-on jetting and said supplemental jetting is performed by a single jetting device.

6. (Original) The method according to claim 2 or 3, wherein said step of correcting comprises the step of removing amounts of viscous medium from positions on the substrate.

7. (Original) The method according to claim 2 or 3, wherein said step of determining errors comprises the step of evaluating all of the determined errors and deciding on whether the determined errors shall be corrected.

8. (Original) The method according to claim 1, further comprising the step of applying at least one viscous medium through said add-on jetting which is different from the viscous medium applied through screen printing.

9-18 (Cancelled)

19. (Currently Amended) A method of applying viscous medium on a substrate, ~~said substrate being arranged for mounting of components thereon~~, said method comprising the steps of:

providing a substrate arranged for mounting of electronic components thereon;
screen printing a viscous medium onto the substrate; and
jetting additional viscous medium onto the substrate ~~prior to hardening of~~ while the screen printed viscous medium is still in viscous form.

20. (Currently Amended) A method of applying additional viscous medium on a substrate that has been screen printed with viscous medium, ~~said substrate being arranged for mounting of components thereon~~, said method comprising the step of:

providing a substrate arranged for mounting of electronic components thereon; and
jetting additional viscous medium onto the substrate ~~prior to hardening of~~ while the screen printed viscous medium is still in viscous form.

21-30 (Canceled)

31. (Previously Presented) The method according to claim 1, wherein said step of add-on jetting includes the step of jetting individual droplets at said predetermined positions on the screen printed substrate.

32-33 (Canceled)

34. (Previously Presented) The method according to claim 31, wherein each of the individual droplets of viscous medium are of a predetermined volume.

35-36 (Canceled)

37. (Previously Presented) The method according to claim 1, wherein said viscous medium applied through said add-on jetting is solder paste.

38. (Previously Presented) The method according to claim 31, wherein said viscous medium applied through said add-on jetting is solder paste.

39. (Currently Amended) A method of applying viscous medium on a substrate, ~~said substrate being arranged for mounting of components thereon~~, said method comprising the steps of:

providing a substrate arranged for mounting of electronic components thereon;

screen printing predetermined amounts of a viscous medium on predetermined positions on the substrate; and

add-on jetting of individual droplets of viscous medium on predetermined positions on the screen printed substrate ~~prior to hardening of~~ while the screen printed viscous medium is still in viscous form.

40. (Previously Presented) The method according to claim 39, wherein said viscous medium applied through said add-on jetting is solder paste.

41. (Currently Amended) A method of applying viscous medium on a substrate, ~~said substrate being arranged for mounting of components thereon~~, said method comprising the steps of:

providing a substrate arranged for mounting of electronic components thereon;

screen printing predetermined amounts of a viscous medium on predetermined positions on the substrate; and

add-on jetting of solder paste on predetermined positions on the screen printed substrate ~~prior to hardening of~~ while the screen printed viscous medium is still in viscous form.

42. (Previously Presented) The method according to claim 1, further comprising the step of applying at least one viscous medium through said add-on jetting which is the same as the viscous medium applied through screen printing.

43. (New) The method according to claim 1, 19, 20, 39 or 41, further comprising the step of mounting electronic components on the substrate.

44. (New) The method according to claims 1, 19, 20, 39, 41 or 43, wherein at least some of said jetting is performed onto positions on the screen printed substrate already provided with viscous medium through said screen printing.